

REMARKS

Applicants note the filing of an Information Disclosure Statement herein on October 17, 2001 and note that no copy of the PTO-1449 was returned with the outstanding Office Action. Applicants respectfully request that the information cited on the PTO-1449 be made of record herein.

The Office Action mailed December 11, 2001, has been received and reviewed. In the Office Action claims 1 through 16 are stated to be currently pending in the application. Claims 6 through 12 and 15 are allowed. Claims 1 through 5 and 13 stand rejected. Claims 14 and 16 have been objected to as being dependent upon rejected base claims, but the indication of allowable subject matter in such claims is noted with appreciation. Applicants note that in an Amendment dated September 5, 2001, Applicants canceled claim 8 and that such is not reflected in the Office Action mailed December 11, 2001.

Per this response, Applicants have cancelled claim 14, amended claim 1 and respectfully request reconsideration of the application as amended herein.

35 U.S.C. § 102(b) Anticipation Rejections

Anticipation Rejection Based on U.S. Patent No. 5,521,427 to Chia et al.

Claims 1 through 5 stand rejected under 35 U.S.C. § 102(b) as being anticipated by Chia et al. (U.S. Patent No. 5,521,427). Applicants respectfully traverse this rejection, as hereinafter set forth.

A claim is anticipated only if each and every element as set forth in the claim is found, either expressly or inherently described, in a single prior art reference. *Verdegaal Brothers v. Union Oil Co. of California*, 2 USPQ2d 1051, 1053 (Fed. Cir. 1987). The identical invention must be shown in as complete detail as is contained in the claim. *Richardson v. Suzuki Motor Co.*, 9 USPQ2d 1913, 1920 (Fed. Cir. 1989).

Claim 1 of the presently claimed invention has been amended to include the subject matter previously set forth in claim 14. Claim 14 has been indicated by the Examiner to contain

allowable subject matter. Applicants, therefore, submit that claim 1 is in condition for allowance and respectfully request the same.

Applicants further submit that claims 2 through 5 are likewise in condition for allowance and respectfully request reconsideration and allowance thereof.

Double Patenting Rejection Based on U.S. Patent No. 5,933,743

Claim 13 stands rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claim 1 of U.S. Patent No. 6,246,108. In order to avoid further expenses and time delay, Applicants elect to expedite the prosecution of the present application by filing a terminal disclaimer to obviate the double patenting rejections in compliance with 37 CFR §1.321 (b) and (c). Applicants' filing of the terminal disclaimer should not be construed as acquiescence of the Examiner's double patenting or obviousness-type double patenting rejections. Attached is the terminal disclaimer and accompanying fee.

Objection to Claim 16/Allowable Subject Matter

Claims 14 and 16 stand objected to as being dependent upon rejected base claims, but are indicated to contain allowable subject matter and would be allowable if placed in appropriate independent form.

Applicants note that claim 13, from which claim 16 depends, is now in condition for allowance and, thus, claim 16 is likewise in condition for allowance. Applicants, therefore, respectfully request reconsideration of claim 13.

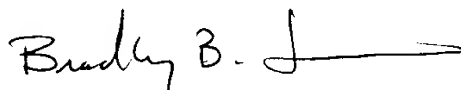
ENTRY OF AMENDMENTS

The amendments to claim 1 above should be entered by the Examiner because the amendments are supported by the as-filed specification and drawings and do not add any new matter to the application.

CONCLUSION

Claim 1 through 13, 15 and 16 are believed to be in condition for allowance, and an early notice thereof is respectfully solicited. Should the Examiner determine that additional issues remain which might be resolved by a telephone conference, he is respectfully invited to contact Applicants' undersigned attorney.

Respectfully Submitted,



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Enclosure: Version With Markings to Show Changes Made

N:\2269\3770.3\Amendment 2.wpd

VERSION WITH MARKINGS TO SHOW CHANGES MADE

1. (Twice Amended) An integrated circuit package comprising:
a semiconductor die;
a lead frame including a plurality of conductors, at least some of which are coupled to the semiconductor die;
insulating material encompassing the semiconductor die and at least a portion of the lead frame;
and
at least one alignment feature formed in the lead frame separate from the plurality of conductors and at least partially external to the insulating material, the at least one alignment feature being configured to facilitate positive alignment of the integrated circuit package with an external structure and wherein the at least one alignment feature is configured to be removable from the integrated circuit package.